

SPECIFICATION

DEVICE NAME : Power MOSFET

TYPE NAME : 2SK2690-01

SPEC. NO. :

Fuji Electric Co.,Ltd.

This Specification is subject to change without notice.

	DATE	NAME	APPROVED	Fuji Electric Co.,Ltd.	
DRAWN				DRG. NO.	1/B
CHECKED					

- 1.Scope This specifies Fuji Power MOSFET 2SK2690-01
- 2.Construction N-Channel enhancement mode power MOSFET
- 3.Applications for Switching
- 4.Outview T0-3P Outview See to 5/13 page

5.Absolute Maximum Ratings at Tc=25°C (unless otherwise specified)

Description	Symbol	Characteristics	Unit	Remarks
Drain-Source Voltage	V _{DS}	60	V	
Continuous Drain Current	I _D	±80	A	
Pulsed Drain Current	I _{DP}	±320	A	
Gate-Source Voltage	V _{GS}	±20	V	
Maximum Avalanche Energy	E _{AV}	599	mJ	*1
Maximum Power Dissipation	P _D	125	W	
Operating and Storage	T _{ch}	150	°C	
Temperature range	T _{stg}	-55 to +150	°C	

*1 L=0.125mH,V_{CC}=24V

6.Electrical Characteristics at Tc=25°C (unless otherwise specified)

Static Ratings

Description	Symbol	Conditions	min.	typ.	max.	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	I _D =1mA V _{GS} =0V	60			V
Gate Threshold Voltage	V _{GS(th)}	I _D =1mA V _{DS} =V _{GS}	1.0	1.5	2.0	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =60V V _{GS} =0V	T _{ch} =25°C	10	500	μA
			T _{ch} =125°C	0.2	1.0	mA
Gate-Source Leakage Current	I _{GSS}	V _{GS} =20V V _{DS} =0V		10	100	nA
Drain-Source On-State Resistance	R _{DS(on)}	I _D =40A	V _{GS} =4V	12	17	mΩ
			V _{GS} =10V	7.5	10	

Dynamic Ratings

Description	Symbol	Conditions	min.	typ.	max.	Unit
Forward Transconductance	g_{fs}	$I_D=40A$ $V_{DS}=25V$	25	55		S
Input Capacitance	C_{iss}	$V_{DS}=25V$		3500	5250	pF
Output Capacitance	C_{oss}	$V_{GS}=0V$		1250	1870	
Reverse Transfer Capacitance	C_{rss}	$f=1MHz$		360	540	
Turn-On Time	$t_{d(on)}$	$V_{CC}=30V$		15	23	ns
	t_r	$V_{GS}=10V$		75	120	
Turn-Off Time	$t_{d(off)}$	$I_D=75A$		190	285	
	t_f	$R_{GS}=10\Omega$		110	165	

Reverse Diode

Description	Symbol	Conditions	min.	typ.	max.	Unit
Avalanche Capability	I_{AV}	$L=100\mu H$ $T_{ch}=25^\circ C$ See Fig.1 and Fig.2	80			A
Diode Forward On-Voltage	V_{SD}	$I_F=160A$ $V_{GS}=0V$ $T_{ch}=25^\circ C$		1.15	1.65	V
Reverse Recovery Time	t_{rr}	$I_F=80A$		75	120	ns
Reverse Recovery Charge	Q_{rr}	$-di/dt=100A/\mu s$ $T_{ch}=25^\circ C$		0.17		μC

7. Thermal Resistance

Description	Symbol	min.	typ.	max.	Unit
Channel to Case	$R_{th(ch-c)}$			1.00	$^\circ C/W$
Channel to Ambient	$R_{th(ch-a)}$			35.0	$^\circ C/W$

Fig. 1 Test Circuit

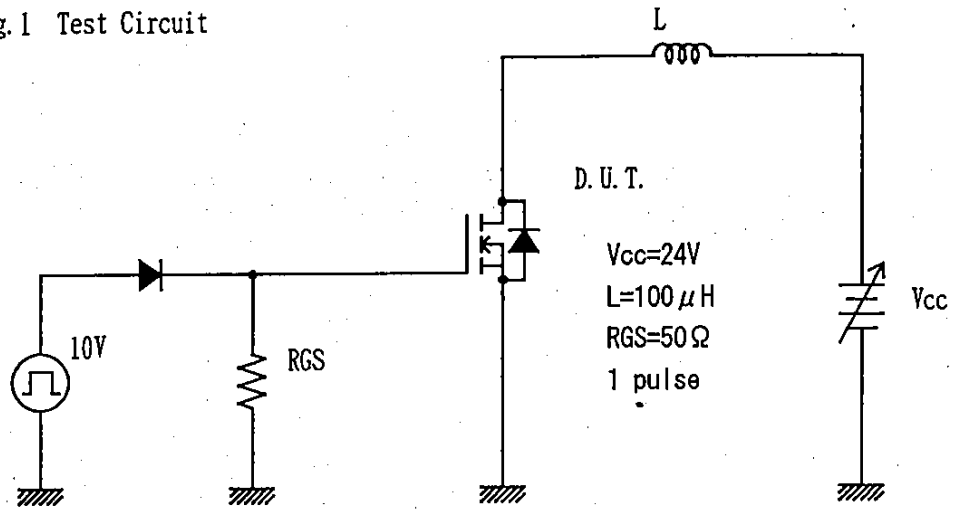
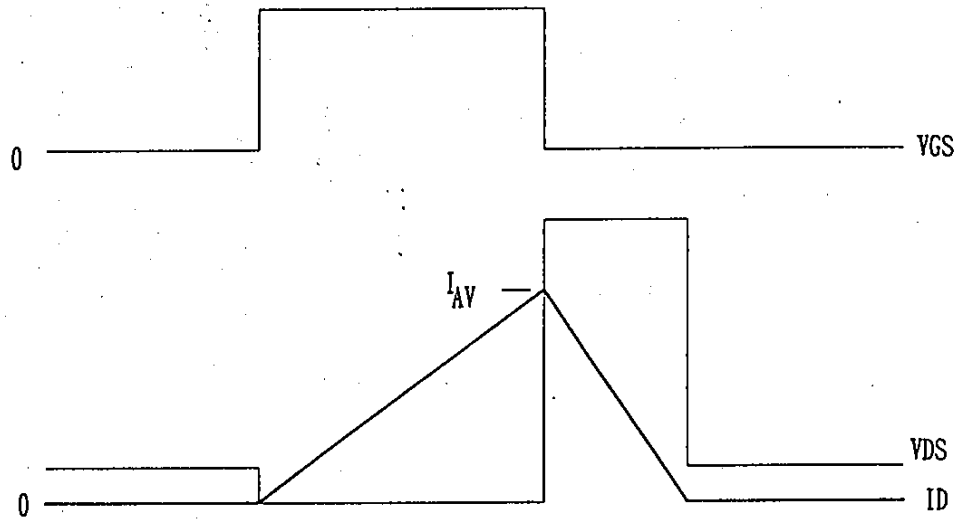
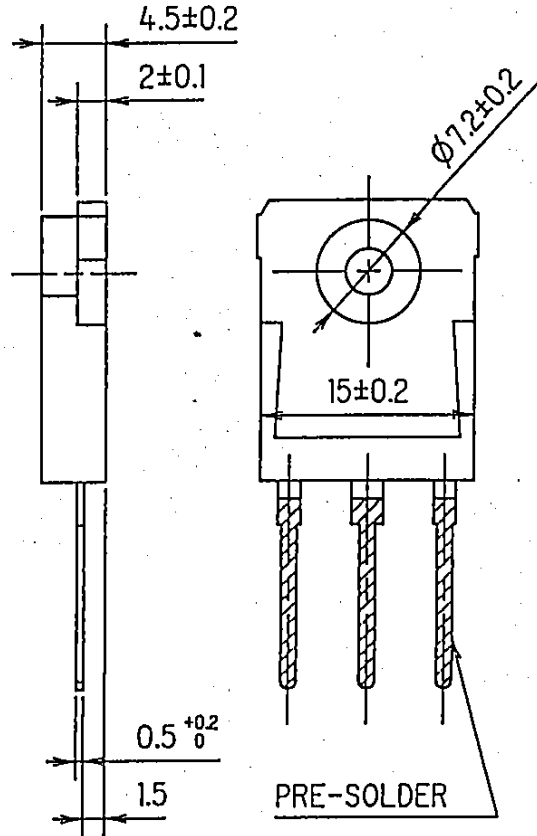
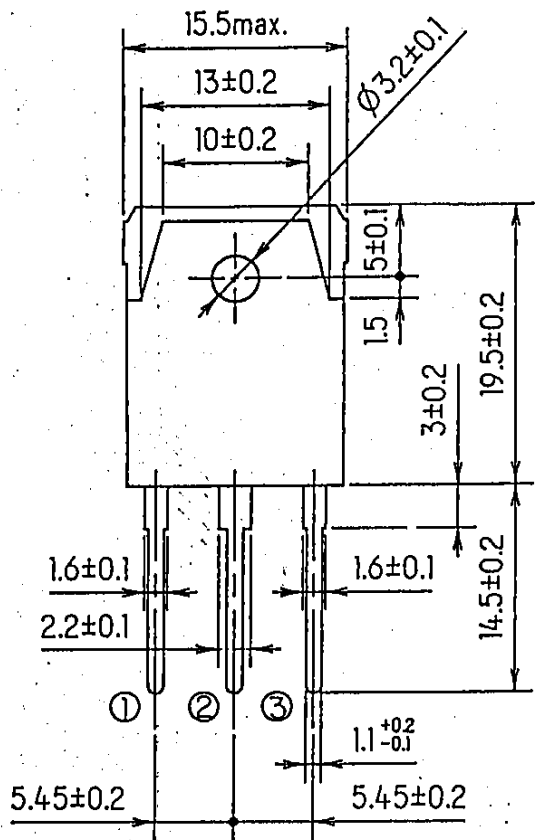
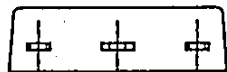


Fig. 2 Operating waveforms





DIMENSIONS ARE IN MILLIMETERS.



① ② ③

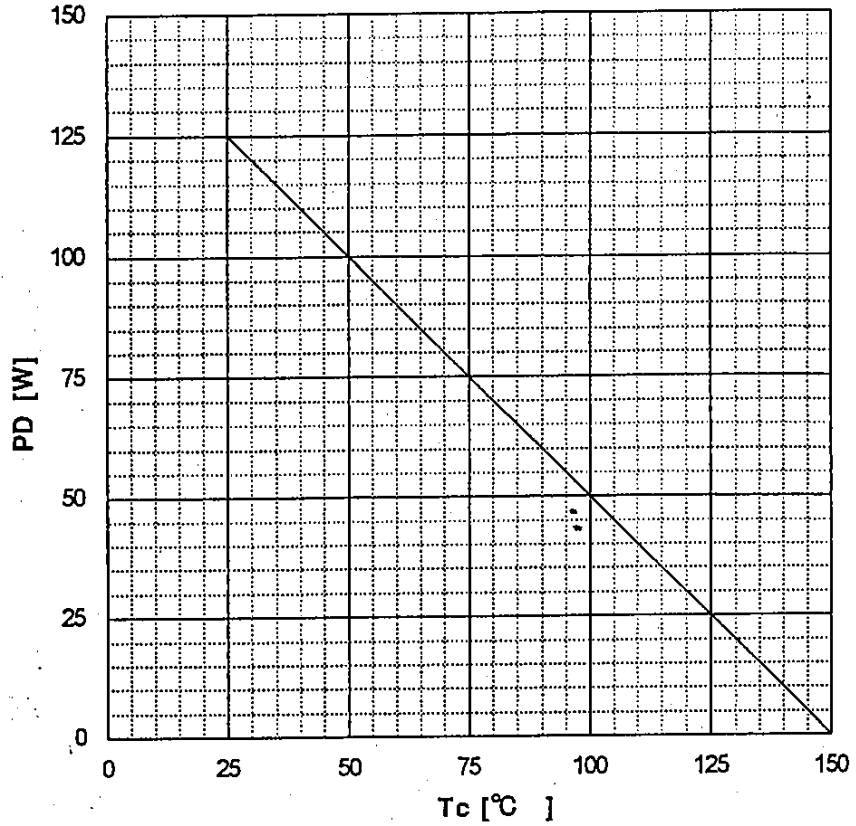
CONNECTION

- ① GATE
- ② DRAIN
- ③ SOURCE

JEDEC : TO-228AA
EIAJ : SC-65

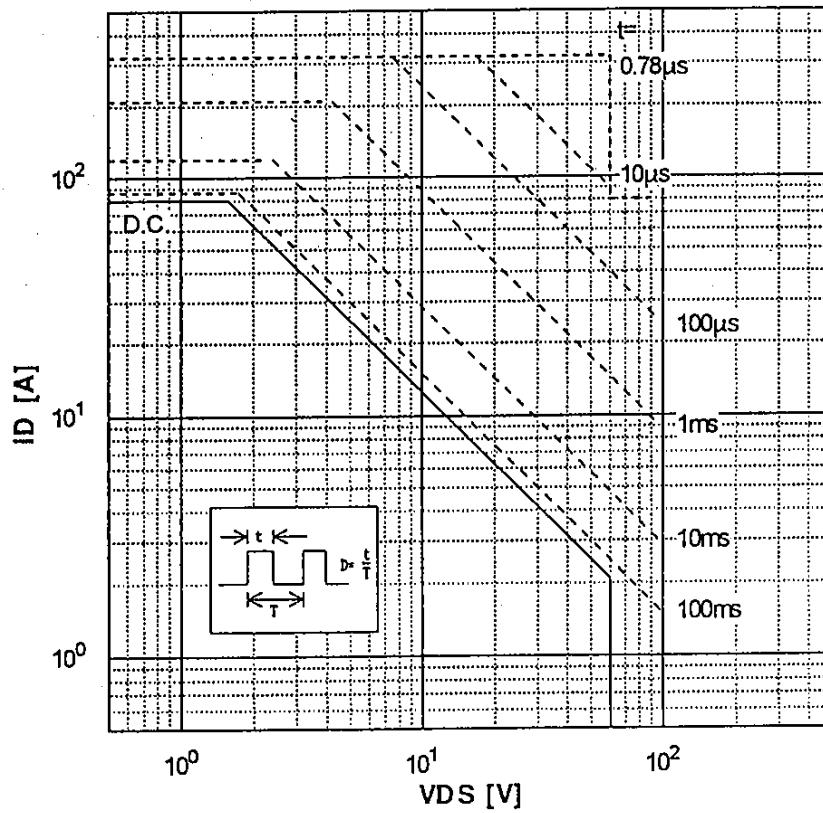
Power Dissipation

$PD=f(T_c)$

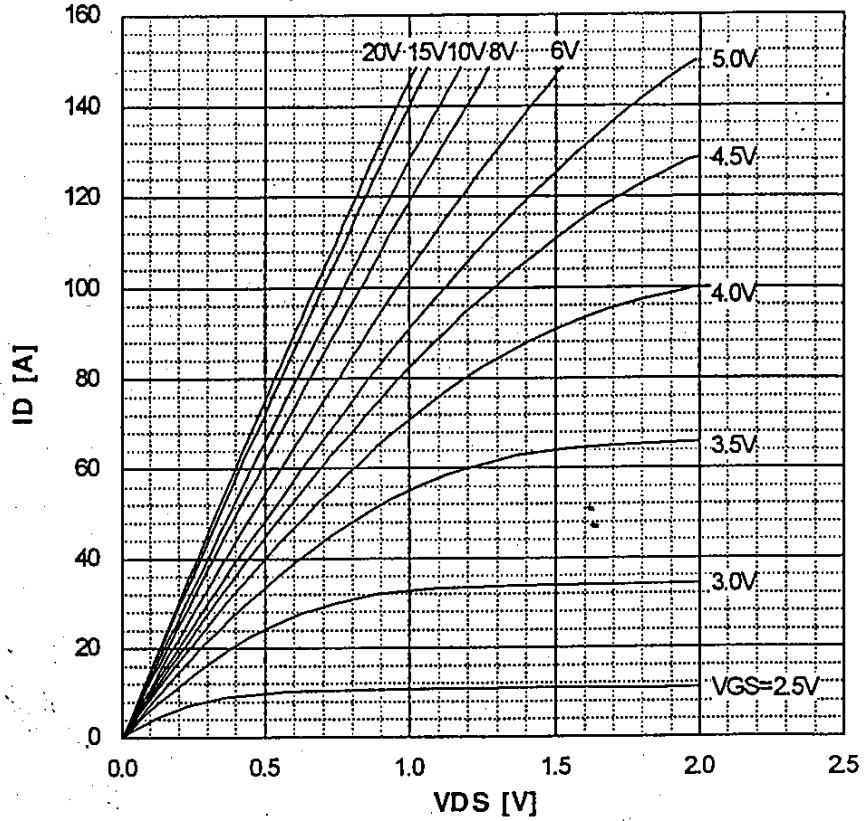


Safe operating area

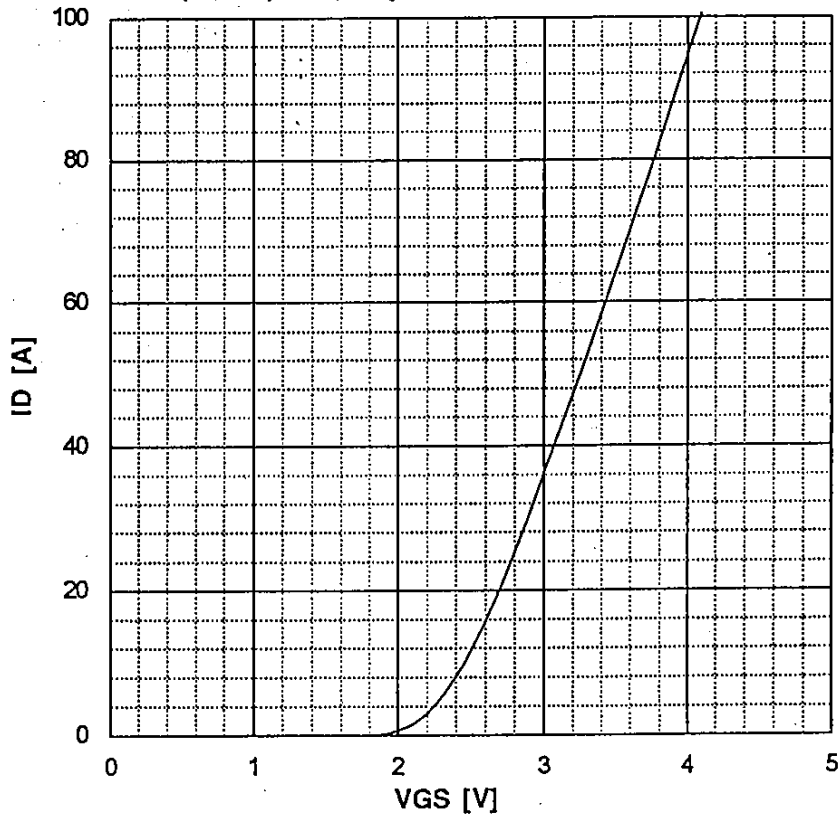
$ID=f(V_{DS}):D=0.01, T_c=25^\circ C$



Typical Output Characteristics
 $I_D = f(V_{DS})$: 80 μ s pulse test, $T_{ch} = 25^\circ\text{C}$

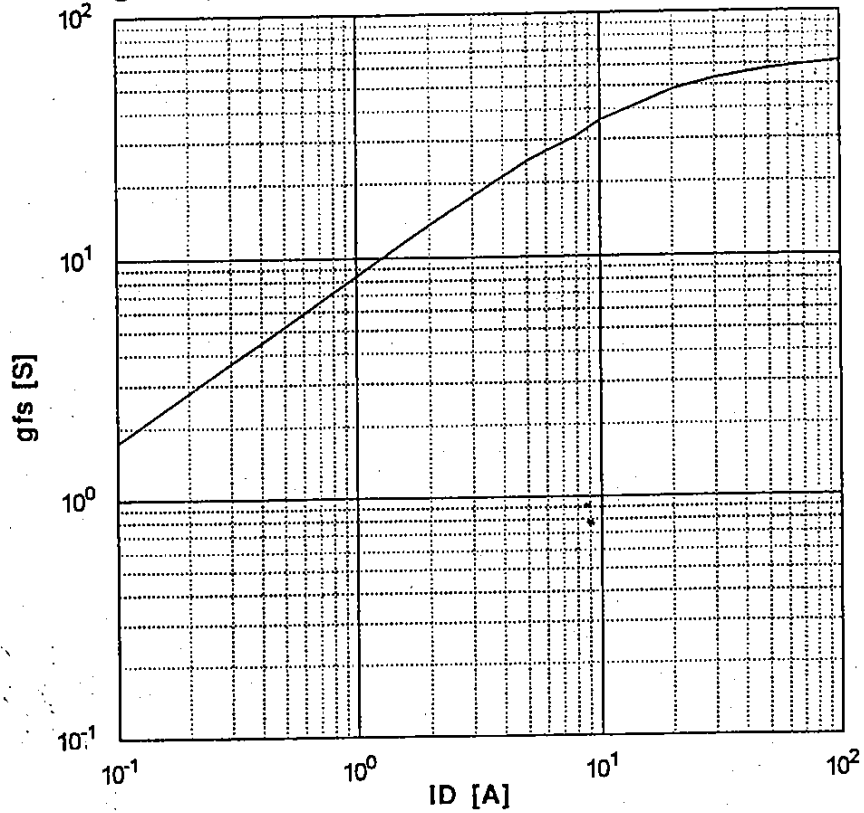


Typical Transfer Characteristic
 $I_D = f(V_{GS})$: 80 μ s pulse test, $V_{DS} = 25\text{V}$, $T_{ch} = 25^\circ\text{C}$



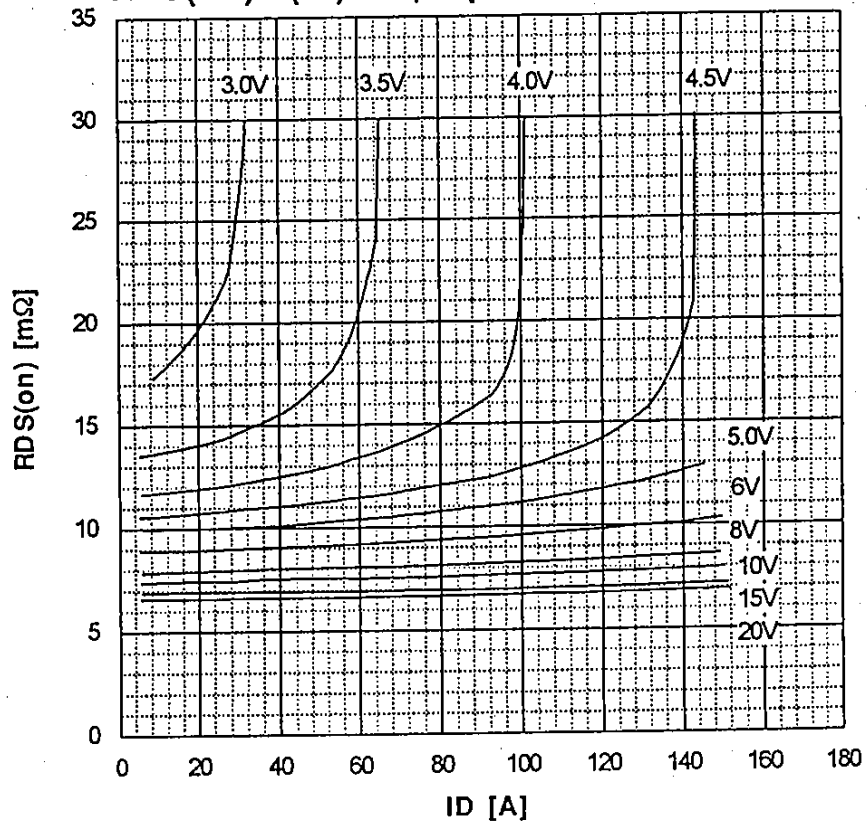
Typical Transconductance

$g_{fs}=f(I_D)$: 80 μ s pulse test, $V_{DS}=25V$, $T_{ch}=25^\circ C$

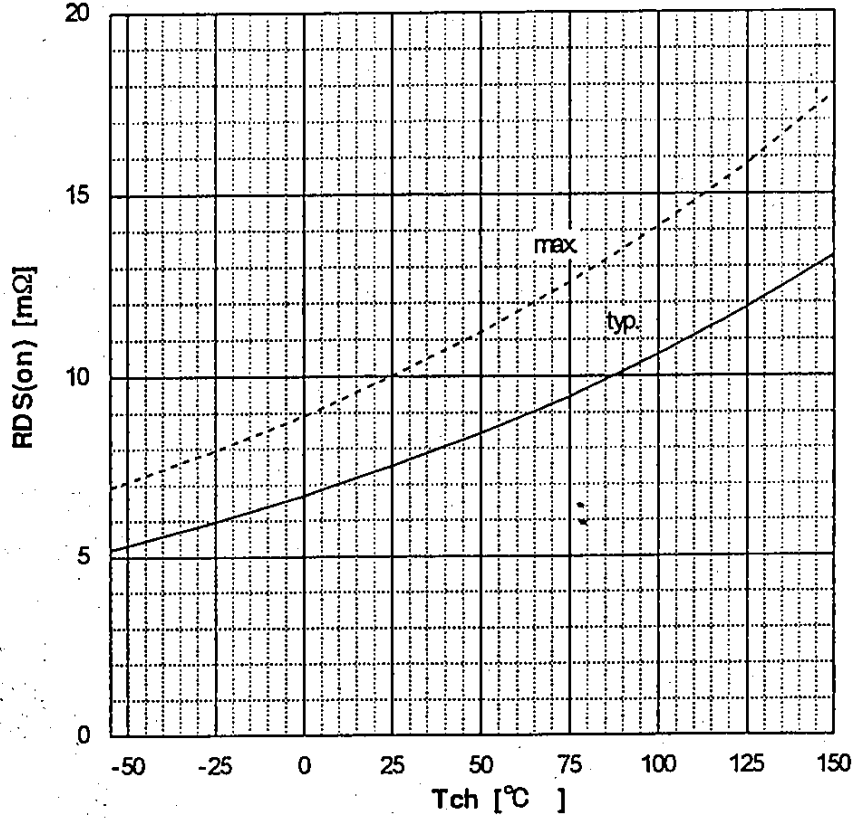


Typical Drain-Source on-State Resistance

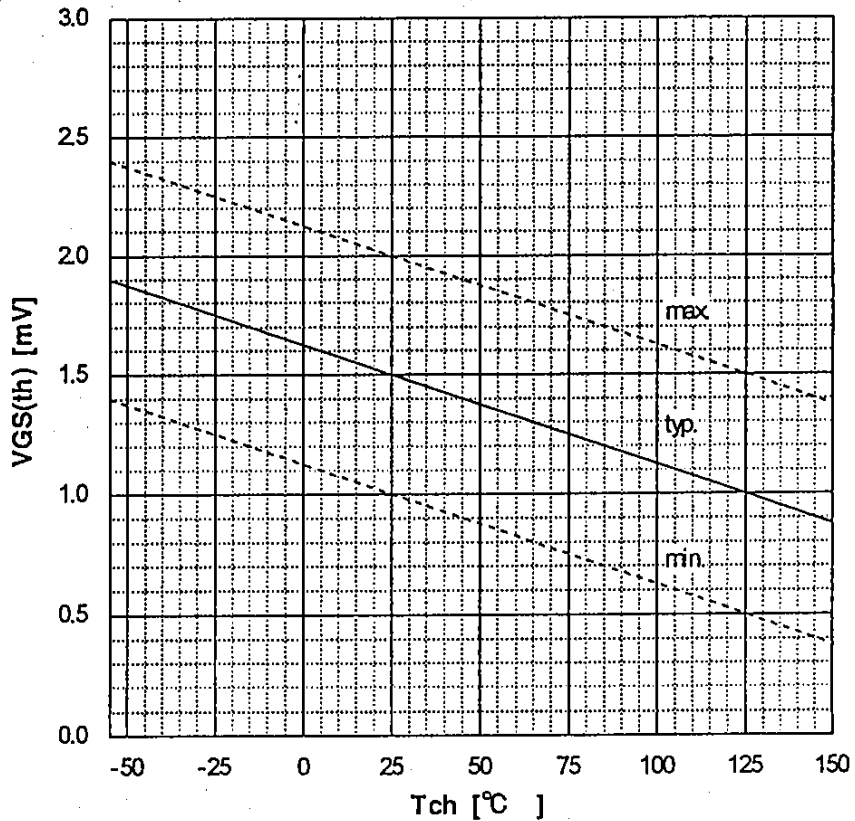
$R_{DS(on)}=f(I_D)$: 80 μ s pulse test, $T_{ch}=25^\circ C$



Drain-Source On-state Resistance
 $R_{DS(on)} = f(T_{ch}) : I_D = 40A, V_{GS} = 10V$

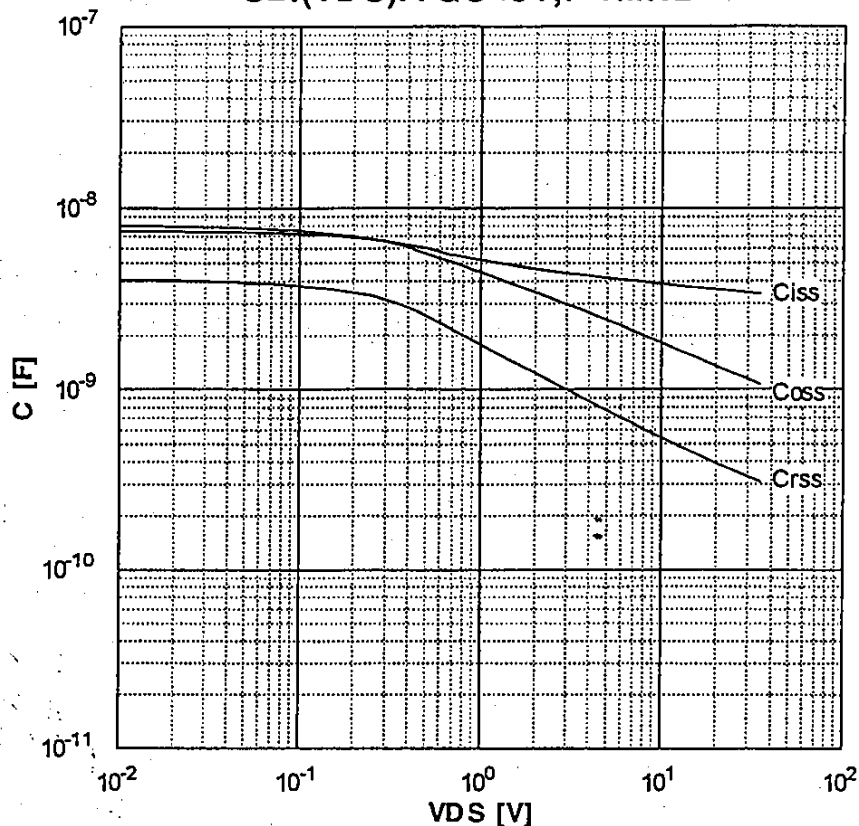


Gate Threshold Voltage vs. T_{ch}
 $V_{GS(th)} = f(T_{ch}) : V_{DS} = V_{GS}, I_D = 1mA$



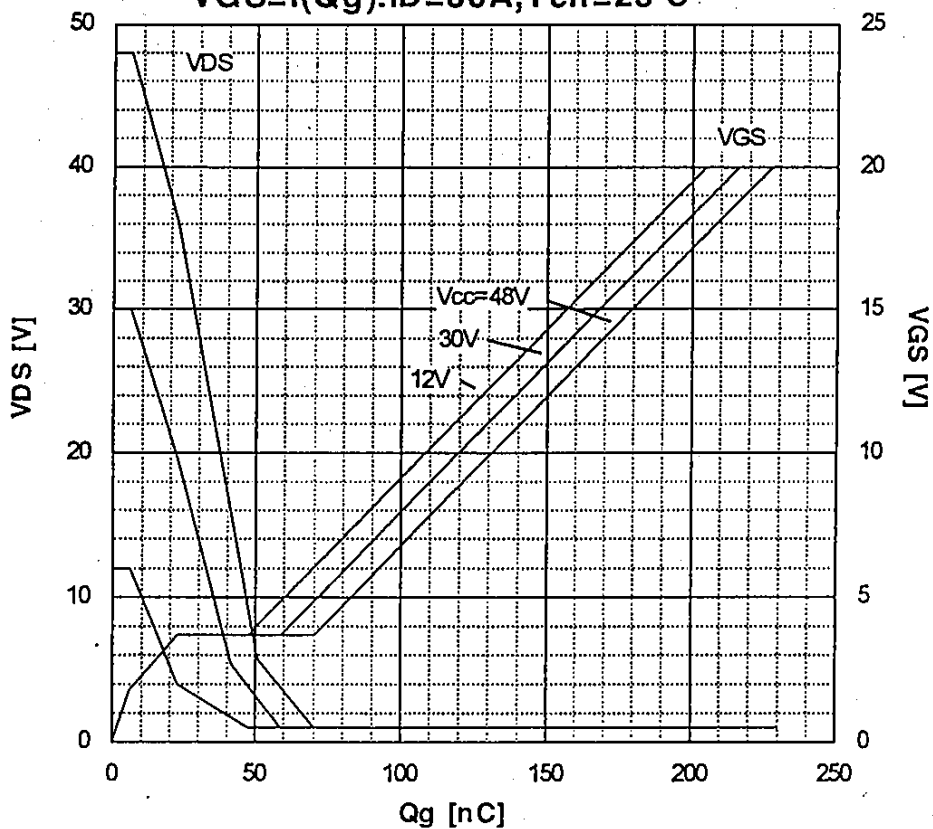
Typical Capacitance

$C=f(V_{DS}):V_{GS}=0V, f=1MHz$



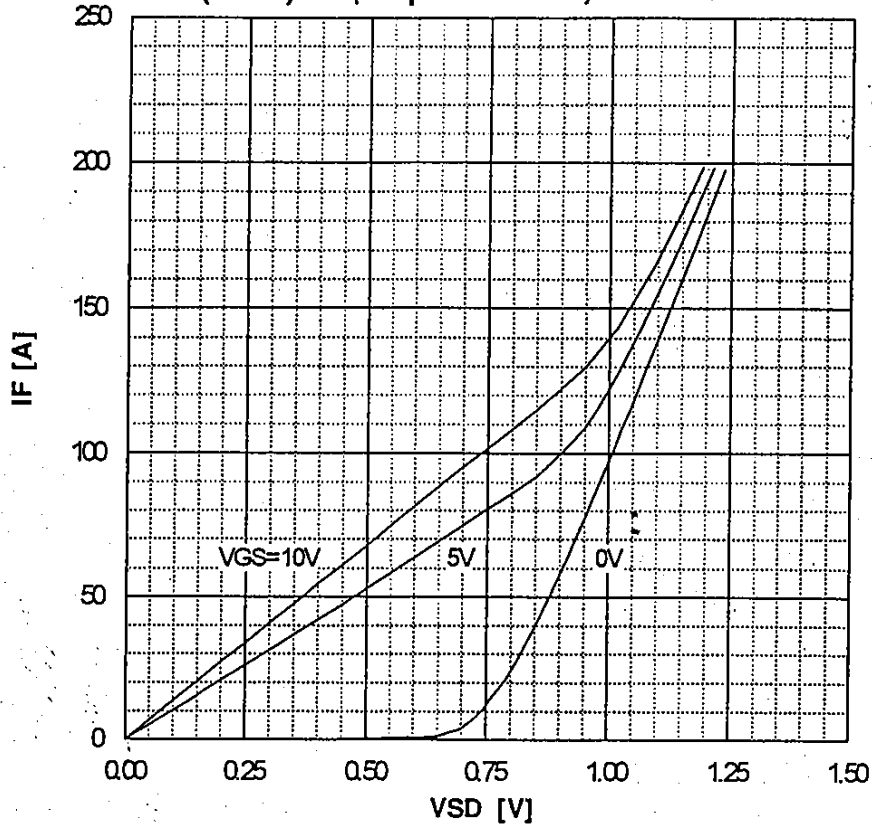
Typical Gate Charge Characteristics

$V_{GS}=f(Q_g):I_D=80A, T_{ch}=25^\circ C$



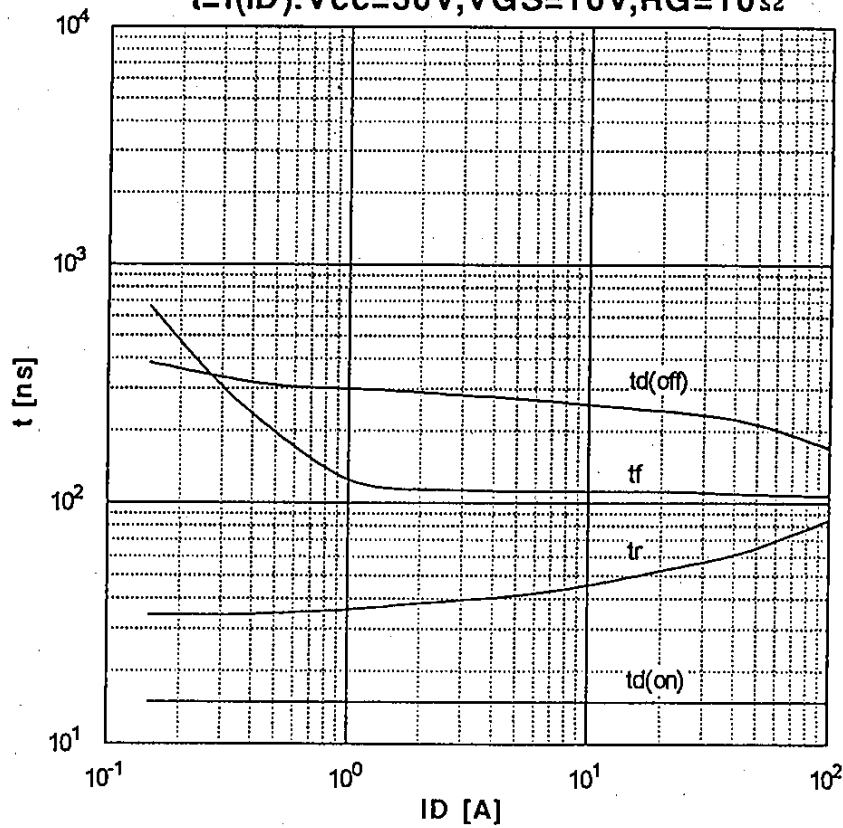
Typical Forward Characteristics of Reverse Diode

$I_F = f(V_{SD})$: 80 μ s pulse test, $T_{ch} = 25^\circ\text{C}$



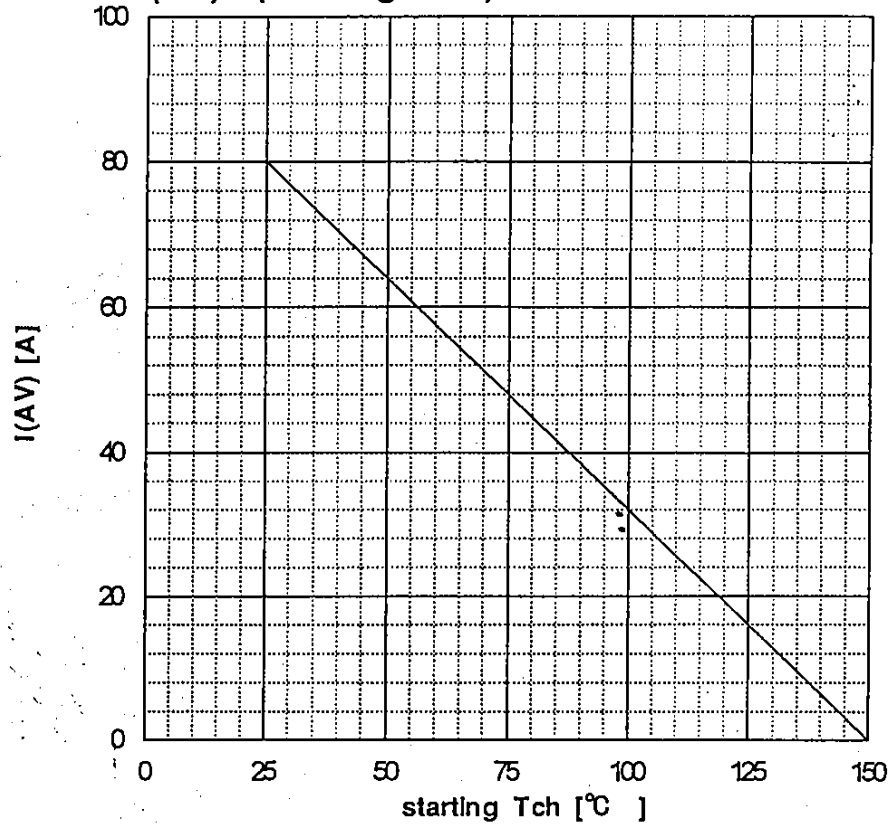
Typical Switching Characteristics vs. ID

$t = f(I_D)$: $V_{CC} = 30\text{V}$, $V_{GS} = 10\text{V}$, $R_G = 10\Omega$



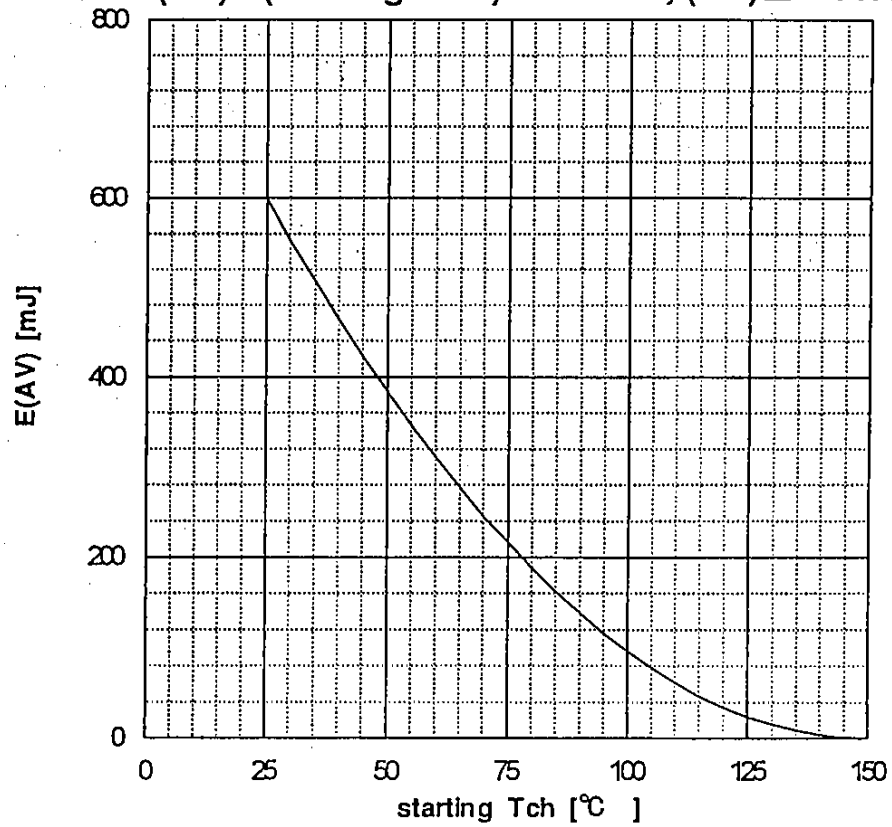
Maximum Avalanche Current vs. starting Tch

$I(AV)=f(\text{starting Tch})$



Maximum Avalanche Energy vs. starting Tch

$E(AV)=f(\text{starting Tch}); V_{cc}=24V, I(AV) \leq 80A$



Transient Thermal impedance
 $Z_{th}(ch-c) = f(t)$ parameter: $D = t/T$

